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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/649,577	08/26/2003	Douglas A. Hawks	050324-1161	5977	
24504 7	590 03/27/2006		EXAMINER		
	AYDEN, HORSTEME' A PARKWAY, NW	TRINH, MICH	TRINH, MICHAEL MANH		
STE 1750	ATAIXWAT, NW		ART UNIT	PAPER NUMBER	
ATLANTA, GA 30339-5948			2822	·	

DATE MAILED: 03/27/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s)	
10/649,577	HAWKS ET AL.	ACA
Examiner ,	Art Unit	An
Michael Trinh	2822	

·	Michael Trinh	2822	
The MAILING DATE of this communication appe	ars on the cover sheet with the c	orrespondence add	ress
THE REPLY FILED 10 March 2006 FAILS TO PLACE THIS AP	PLICATION IN CONDITION FOR	ALLOWANCE.	
 The reply was filed after a final rejection, but prior to or on this application, applicant must timely file one of the follow places the application in condition for allowance; (2) a No a Request for Continued Examination (RCE) in compliance time periods: 	ving replies: (1) an amendment, aft tice of Appeal (with appeal fee) in one with 37 CFR 1.114. The reply mo	fidavit, or other evider compliance with 37 C	ce, which FR 41.31; or (3)
a) The period for reply expiresmonths from the mailing b) \[\begin{align*} The period for reply expires on: (1) the mailing date of this A no event, however, will the statutory period for reply expire to Examiner Note: If box 1 is checked, check either box (a) or (TWO MONTHS OF THE FINAL REJECTION. See MPEP 7)	dvisory Action, or (2) the date set forth ater than SIX MONTHS from the mailin (b). ONLY CHECK BOX (b) WHEN THE 06.07(f).	g date of the final rejection in the graph of the graph o	on. ILED WITHIN
Extensions of time may be obtained under 37 CFR 1.136(a). The date have been filed is the date for purposes of determining the period of ex under 37 CFR 1.17(a) is calculated from: (1) the expiration date of the set forth in (b) above, if checked. Any reply received by the Office later may reduce any earned patent term adjustment. See 37 CFR 1.704(b) NOTICE OF APPEAL	tension and the corresponding amount shortened statutory period for reply orig than three months after the mailing da	of the fee. The appropri inally set in the final Offi- te of the final rejection, of	ate extension fee ce action; or (2) as even if timely filed,
 The Notice of Appeal was filed on A brief in comp filing the Notice of Appeal (37 CFR 41.37(a)), or any exter a Notice of Appeal has been filed, any reply must be filed AMENDMENTS 	nsion thereof (37 CFR 41.37(e)), to	avoid dismissal of th	s of the date of e appeal. Since
 3. The proposed amendment(s) filed after a final rejection, (a) They raise new issues that would require further composition (b) They raise the issue of new matter (see NOTE belomotion) They are not deemed to place the application in bet appeal; and/or (d) They present additional claims without canceling a second content of the present additional claims. 	nsideration and/or search (see NO w); ter form for appeal by materially re	TE below);	
NOTE: <u>See Continuation Sheet</u> . (See 37 CFR 1.14. The amendments are not in compliance with 37 CFR 1.15. Applicant's reply has overcome the following rejection(s) Newly proposed or amended claim(s) would be all	16 and 41.33(a)). 21. See attached Notice of Non-Co :	mpliant Amendment (•
non-allowable claim(s). 7. For purposes of appeal, the proposed amendment(s): a) how the new or amended claims would be rejected is provided the status of the claim(s) is (or will be) as follows: Claim(s) allowed: Claim(s) objected to: Claim(s) rejected: 1-8,16,17 and 20-27. Claim(s) withdrawn from consideration:	☑ will not be entered, or b) ☐ wi vided below or appended.	ll be entered and an e	xplanation of
AFFIDAVIT OR OTHER EVIDENCE			
 The affidavit or other evidence filed after a final action, bu because applicant failed to provide a showing of good and was not earlier presented. See 37 CFR 1.116(e). 	d sufficient reasons why the affidav	it or other evidence is	necessary and
 The affidavit or other evidence filed after the date of filing entered because the affidavit or other evidence failed to o showing a good and sufficient reasons why it is necessary 	vercome all rejections under appea	al and/or appellant fai	ls to provide a
10. ☐ The affidavit or other evidence is entered. An explanation REQUEST FOR RECONSIDERATION/OTHER		•	
 The request for reconsideration has been considered bu <u>See Continuation Sheet.</u> 			ice because:
12. ☐ Note the attached Information Disclosure Statement(s).13. ☐ Other:	(PTO/SB/08 or PTO-1449) Paper N	lo(s) Michael Trini Primary Examina	S S

Continuation of 3. NOTE: Further consideration for objecting of these claims 1-8,16-17,20-27 is needed since many claimed terms/words are partially crossed out and deleted due to the inclusion of two solid vertical lines in the claim pages (for example, see attached page 4).

Continuation of 11. does NOT place the application in condition for allowance because: of rejections and clear reasons as of record.

** Applicant alleged that Yamaguchi fails to disclose "...attaching a removable mateiral to a surface of conductive mateiral before one or more isolated conductive features have been formed...", since Yamaguchi teaches "...a metal plate for lead frame 21 made of copper, for example, is etched or pressed" and "a pad assembly 16 including die pads 14, connection portions 16s and frame 16 is formed by etching or pressing another metal plate...Subsequently,...a plastic film 12...is attached...".

In response, this is noted and found unconvincing. Although there is a step of etching and pressing to form some portions the lead frame, Yamaguchi clearly teaches the claimed invention of "...attaching a removable mateiral to a surface of conductive mateiral before one or more isolated conductive features have been formed...". Indeed, as clearly taught by Yamaguchi at column 8, lines 45-67, after attaching the pad assembly 16 to the plastic removable material film 12, the connection portions 16a of the pad assembly 16 are cut off thereby separating the die pad 14 from the frame 16b of the pad assembly 16 in order to form one or more isolated conductive features 14. Claimed subject matter, not the specification, is a measure of the invention

** Applicant remarked that Glenn fails to disclose "...wherein the removing said material step is performed after the singulation process is performed to separate said package...".

In response this is noted and found unconvincing. Under 103 rejection, Yâmaguchi teaches (at col 11, lines 41-64; Figs 7e-79 removing the removable material 12 either prior to a singulation process to separate the package (col 1 1, lines 41-61) or after a singulation process to separate the package (col 1 1, lines 62-64). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to remove the removable material of Glenn either aher a singulation process to separate the package or prior to a singulation process as alternatively taught by Yamaguchi. This is because removing the removable material either ager or prior to the singulation process are alternative and art recorized equivalent processes for substitution in fabrication of the electronic device, and because of the desirability to expose a portion of the metal lead frame and conductive features for subsequent electrical connection, wherein by removing the removable material aRer singulation process, the removable material would still cover and thereby consequently protect the metal lead gnme gom being contominated during singulation process.

The rejections are outstanding and maintained.

Michael Trinin Primary Examiner